The product described herein has not been fully tested to ensure conformance to the requirements outlined below. TE Connectivity makes no representation or warranty, express or implied, that the product will comply with these requirements. Further, TE may change these requirements based on the results of additional testing and evaluation. Contact TE Engineering for further details.

Design Objective (108-115184)

1. 25mm Pitch Wire to Board Connector with Latch

- 1. Scope:
- 1.1 Contents:

This specification covers the requirements for product performance, test methods and quality assurance provisions of 1.25mm Pitch Wire to Board Connector with Latch Applicable product description and part numbers are as shown in Fig.1.

2. Applicable Documents

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements this specification and referenced documents, this specification shall take precedence.

- 2.1 AMP Specifications:
 - A. 109-5000 Test Specification, General Requirements for Test Methods
 - B. 501-115199 Test Report



2.2 Commercial Standards and Specifications:

A. EIA-364: Test Methods for Electronic and Electrical Component Parts.

(Always use latest version for test)

The application product descriptions and part numbers are as shown in Fig. 1

| Product Part No. | Description | | |
|---------------------|--|--|--|
| x-2390144 -x | Cable Housing of 1.5mm Pitch Wire to Board Connector with Latch | | |
| 2390147 - x | Cable Contact of 1.5mm Pitch Wire to Board Connector with Latch | | |
| x-2390138- x | Vertical Type Board Side of 1.25mm Pitch Wire to Board Connector with Latch | | |
| x-2390136 -x | Right Angle Type Board Side of 1.25mm Pitch Wire to Board Connector with Latch | | |
| Fig. 1 (Single row) | | | |

| Product Part No. | Description | | |
|---------------------|--|--|--|
| x-2390905 -x | Cable Housing of 1.5mm Pitch Double row WTB Connector with Latch | | |
| 2390914 - x | Cable Contact of 1.5mm Pitch Double row WTB Connector with Latch | | |
| x-2390892- x | Vertical Type Board Side of 1.25mm Pitch Double row WTB Connector with Latch | | |

Fig. 1 (Double row)

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|-----------------|-----------|------------------|----------|-----------|

3. Requirements:

3.1 Design and Construction:

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2 Materials:

A. Board side:

| Contacts: | Gold plating or Tin plating, Copper Alloy |
|------------|---|
| Housing: | LCP, UL94V-0, Natural or Black |
| Metal Peg: | Tin plating, Copper Alloy |

B. Cable side:

| Contacts: | Gold plating or Tin plating, Copper Alloy |
|-----------|---|
| Housing: | Nylon, UL94V-0, Natural or Black |

3.3 Ratings:

- A. Voltage Rating: 50 Volts AC (per pin)
- B. Current Rating (Maximum)
 - AWG # 30~#26: 1 A (per pin)
- C. Temperature Rating: -40° C to $+105^{\circ}$ C

The upper limit of the temperature includes the temperature rising resulted by the energized electrical current.

3.4 Performance Requirements and Test Descriptions:

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Fig.2. All tests shall be performed in the room temperature unless otherwise specified.

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3.5 Test Requirements and Procedures Summary:

| Para. | Test Items | Requirements | Procedures |
|---------|---------------------------------------|---|---|
| 3.6.1 | Examination of product | Product shall be confirming to the requirements of applicable product drawing and applicable Specification | Visual and Dimensional Inspection Test Procedure for Electrical Connectors. EIA-364-18 |
| Electri | ical Requirements | | |
| 3.6.2 | Termination Resistance (Low Level) | 20 mΩ Max. (Initial) $\Delta R < 10 mΩ$ (Final) | Subject mated contacts assembled in housing to 20mV Max. open circuit at 10 mA. EIA-364-23 |
| 3.6.3 | Dielectric withstanding voltage | No creeping discharge or flashover shall occur. Current leakage: 1mA Max. | 500 VAC Min. at sea level for 1 minute Test between adjacent contacts of unmated connectors. (EIA-364-20) |
| 3.6.4 | Insulation Resistance | 100 MΩ Min | Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21) |
| 3.6.5 | Temperature Rising | 30°C max, when apply current rate | Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70 METHOD 2) |

Fig.2. To be continued

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| Para. | Test items | Requirements | | Procedures |
|--------|---|---------------------|------|---|
| Mechan | ical Requirements | · | | |
| 3.6.6 | Connector | See item 6 | | Operation Speed : |
| | Mating/Unmating Force | | | 25.4 ± 3 mm/minute |
| | | | | Measure the force required to mate/unmat connector. |
| | | | | Unmated connector angle θ is +/-20 degree max. See figure 1 |
| | | | | (EIA-364-13) |
| 3.6.7 | Durability (Repeated Mate/Unmating) | 30 cycles | | The sample should be mounted in the teste and fully mated and unmated the number of cycles specified at the rate of |
| | | | | 25.4 ± 3mm/min. |
| | | | | (EIA-364-09) |
| 3.6.8 | Vibration (Low Frequency) | 1 us Max. | | The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. |
| | | | | (EIA-364-28 Condition I) |
| 3.6.9 | Physical Shock | 1 us Max. | | Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A) |
| 3.6.10 | Contact/Metal peg | 2N Min. for contact | | Operation Speed : |
| | Retention Force of Board side | 3N Min. for metal p | eg | 25.4 ± 3 mm/minute. |
| | | | | Measure the contact retention force with Tensile strength tester. |
| 3.6.11 | Crimping Terminal / Housing Retention Force | 5N Min. per pin | | Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. |
| | | | | |
| | | | | |
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| 3.6.12 | Crimping Pull Out Force (Cable Side) | AWG #26: 20N Min. AWG #28: 10N Min. AWG #30: 5N Min. | Operation Speed : 25.4 ± 3 mm/minute. Fix the crimped terminal, apply axial pull out force on the wire. |
|--------|--|--|--|
| 3.6.13 | Locking Force | 2~3pin, 10N Min 4~6pin, 12N Min 7~9pin, 15N Min >10pin, 20N Min | While withdrawing plug & receptacle Without terminal at speed 25.4 ± 3 mm/minute |

Fig. 2 (To be continued)

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| Para | Test Items | Requirements | Procedures | | | | |
|---------|----------------------------------|--|---|--|--|--|--|
| Enviror | Environmental Requirements | | | | | | |
| 3.6.14 | Thermal Shock | See Product Qualification and Test Sequence Group 6 | Mate module and subject to follow condition for 5 cycles. | | | | |
| | | | 1 cycles: | | | | |
| | | | -40 +0/-3 °C, 30 minutes | | | | |
| | | | +105 +3/-0 °C, 30 minutes | | | | |
| | | | (EIA-364-32, test condition A) | | | | |
| 3.6.15 | Humidity | See Product Qualification and | Mated Connector | | | | |
| | | Test Sequence Group 6 | 40°С, 90~95% RH, | | | | |
| | | | 96 hours. | | | | |
| | | | (EIA-364-31,Condition A, Method II) | | | | |
| 3.6.16 | Salt Spray | See Product Qualification and Test Sequence Group 7 | Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II)PURE TIN for 48 hours (EIA-364-26,Test condition B) | | | | |
| 3.6.17 | Temperature Life (Heat Aging) | See Product Qualification and Test Sequence Group 5 | Subject mated connectors to temperature life at 105°C for 96 hours. | | | | |
| | | | (EIA-364-17, Test condition A) | | | | |
| 3.6.18 | Solderability | Solder able area shall have minimum of 95% solder | Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at $245 \pm 5^{\circ}$ C, for 4-5 sec. | | | | |
| | | coverage. | (EIA-364-52) | | | | |
| 3.6.19 | | | Pre Heat : 150°C~180°C, 60~120sec. | | | | |
| | Resistance to Reflow | See Product Qualification and Test Sequence Group 6 (Lead | Heat: 230°C Min., 40sec Min. | | | | |
| | Soldering Heat | Free) | Peak Temp. : 260°CMax, | | | | |
| | | | 10sec Max. | | | | |

Note. Flowing Mixed Gas shell be conduct by customer request.

Fig. 2 (End)

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4. PRODUCT QUALIFICATION AND TEST SEQUENCE

| | Test Group | | | | | | | | | | | |
|--|---------------|--------|---------|--------|------|------|------------|-----|-----|-----|-----|-----|
| Test or Examination | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | ••• | ••• |
| | Test Sequence | | | | | | | | | | | |
| Examination of Product | 1,3 | | 1,5 | 1,5 | 1,6 | 1,7 | 1,4 | 1,3 | 1,3 | 1,3 | | |
| Low Level Contact Resistance | | | 2,7 | 2,6 | 2,7 | 2,8 | 2,5 | | | 4 | | |
| Insulation Resistance | | | | | 3,8 | 3,9 | | | | | | |
| Dielectric Withstanding Voltage | | | | | 4,9 | 4,10 | | | | | | |
| Temperature rise | 2 | | | | | | | | | | | |
| Mating / Unmating Forces | | | 3,6 | | | | | | | | | |
| Contact Retention Force | | 1 | | | | | | | | | | |
| Fitting Nail Retention Force | | 2 | | | | | | | | | | |
| Crimping Pull Out Force | | 3 | | | | | | | | | | |
| Crimping Terminal / Housing Retention Force | | 4 | | | | | | | | | | |
| Durability | | | 4 | | | | | | | | | |
| Vibration | | | | 3 | | | | | | | | |
| Shock (Mechanical) | | | | 4 | | | | | | | | |
| Temperature life | | | | | 5 | | | | | | | |
| Thermal Shock | | | | | | 5 | | | | | | |
| Humidity | | | | | | 6 | | | | | | |
| Salt Spray | | | | | | | 3 | | | | | |
| Solder ability | | | | | | | | 2 | | | | |
| Hand Soldering Temperature Resistance | | | | | | | | | 2 | | | |
| Resistance to Soldering Heat | | | | | | | | | | 2 | | |
| Sample Size | 2 | 4 | 4 | 4 | 4 | 4 | 2 | 4 | 4 | 4 | | |
| Numbers indicate sequence in wh | ich the | e test | s are j | perfoi | med. | | | | | | | |
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5. Mating / Unmating Force:

| | At in | At 30th | |
|----------|--------------------------|---------------------------|---------------------------|
| Pos. No. | Mating Force. (Max) | Unmating Force (Min) | Unmating Force (Min) |
| 2 | 17 | 0.3 | 0.3 |
| 3 | 18 | 0.6 | 0.6 |
| 4 | 19 | 0.9 | 0.9 |
| 5 | 20 | 1.2 | 1.2 |
| 6 | 21 | 1.5 | 1.5 |
| 7 | 22 | 1.8 | 1.8 |
| 8 | 23 | 2.1 | 2.1 |
| 9 | 24 | 2.4 | 2.4 |
| 10 | 25 | 2.7 | 2.7 |
| 11 | 26 | 3.0 | 3.0 |
| 12 | 27 | 3.3 | 3.3 |
| 13 | 28 | 3.6 | 3.6 |
| 14 | 29 | 3.9 | 3.9 |
| 15 | 30 | 4.2 | 4.2 |
| 20 | 50 | 5.0 | 5.0 |
| 30 | 60 | 6.0 | 6.0 |
| 40 | 70 | 7.0 | 7.0 |
| 50 | 80 | 8.0 | 8.0 |

Table 5

6. INFRARED REFLOW CONDITION



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- 7. Handing Precautions
 - 7.1 Precautions for mating operation
 - (1) In the case of large circuit number, do not mate connector by pressing socket housing at only its both ends as indicated by arrows, because non-mating part may occur partly due to deflection of socket housing.Be sure to make connector by pressing the whole of socket housing as shown in Fig.-2

When mating connector, align the edge of header with socket housing, and mate connector on the same axis as shown in Fig.-2

(2) There is a "clock" sound (you feel a click) when mating operation is properly completed. When there is no feeling of a click, there is a possibility that mating is not finished completely. Conduct mating operation again.

(The number of mating and unmating operation shall be decreased as much as possible.)



(1) Press a protrusion as shown in Fig.-3,hold wire in a bundle and unmate socket housing from header with releasing lock completely.

Do not unmate connector forcibly without releasing lock completely ,because such handling may cause deformation of lock part, and breakage of connector.

(2) Do not unmate socket housing from header from slanting condition as shown in Fig.-4,

because socket housing may be deformed.

When socket housing is unmated with holding only several wires at the end of circuit,

even if socket housing is extracted in a straight line against mating axis, such handling

may cause the same condition as prying connector.

Be sure to hold wires in a bundle, and conduct unmating operation within 20 degrees to each direction with releasing lock completely.



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| CRIMPING CONDITION | | | | | | | | | | |
|--------------------|---|-----------|----------------|------------------------|-----------------|------------------------|-----------|--|--|--|
| | Wire | Specifica | ation | Crimp He | ight (mm) | Crimp Wi | dth (mm) | | | |
| Part Number | Part umber UL Style (REF.) AWG Size Insulation C OD (mm) | | Conductor A | Insulation B | Conductor W1 | Insulation W2 | | | | |
| 2390147 - x | UL1061 | 26 | 1.00 | 0.52 [~] 0.56 | 1.05~1.10 | 0.85~0.90 | 0.95~1.00 | | | |
| 2390147 - x | UL1061 | 28 | 0.90 | 0.48~0.52 | 1.00~1.05 | 0.83~0.90 | 0.90~0.98 | | | |
| 2390147 - x | UL1061 | 30 | 0.80 | 0.44~0.50 | 0.95~1.05 | 0.83~0.90 | 0.88~0.95 | | | |
| 2390914- x | UL1061 | 26 | 1.00 | 0.55~0.60 | 1.05~1.10 | 0.90 [~] 0.95 | 0.95~1.00 | | | |
| 2390914- x | UL1061 | 28 | 0.90 | 0.50~0.55 | 1.00~1.05 | 0.88~0.95 | 0.90~0.98 | | | |
| 2390914- x | UL1571 | 30 | 0.70 | 0.45~0.55 | 0.95~1.05 | 0.88~0.95 | 0.88~0.95 | | | |





Strip length

Note:

- 1 W1: Conductor Crimping Width (for reference)
- 2 · W2: Insulation Crimping Width (for reference)
- 3 · A: Conductor Crimping height (for reference)
- 4 . B: Insulation Crimping height (for reference)
- 5、Strip length: 0.7~1.0mm (for reference)

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| Item | Range(Ref.) |
|---------------------------|-------------|
| Max. Up Bend | 6° |
| Max. Down Bend | 6° |
| Max. Left Twist | 5° |
| Max. Right Twist | 5° |
| Bell-Mouth Length | 0.1~0.3mm |
| Carrier Cut Off Length | 0~0.2mm |
| Conductor Extruded Length | 0.05~0.2mm |

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